# mail

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# **BLP05H6700XR;** BLP05H6700XRG Power LDMOS transistor

Rev. 1 — 17 February 2017

AMPLEON Product data sheet

#### **Product profile** 1.

### 1.1 General description

A 700 W extra rugged LDMOS power transistor optimized for broadcast, industrial, aerospace and defense applications in the HF to 600 MHz band.

#### Table 1. **Application information**

Test signal	f	V <sub>DS</sub>	PL	G <sub>p</sub>	η <sub>D</sub>
	(MHz)	(V)	(W)	(dB)	(%)
pulsed RF	108	50	700	26	75

### 1.2 Features and benefits

- Easy power control
- Integrated dual sided ESD protection enables class C operation and complete switch off of the transistor
- Excellent ruggedness VSWR 65 : 1
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 600 MHz)
- 50 V operation for easy broadband matching
- Package available in both straight leads and gull wing form
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications
- Aerospace and defense applications

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# 2. Pinning information

Pin	Description	Simplifi	ed outline	Graphic symbol
BLP05	5H6700XR (SOT1138-2)			
1	gate 2			
2	gate 1		4 3	4
3	drain 1	<u>r-</u>		
4	drain 2			
5	source	[1]		
			1 2	3
				aaa-0035
BLP05	5H6700XRG (SOT1204-2)			
1	gate 2			
2	gate 1		4 3	
3	drain 1			
	drain 2	י-ק	······································	
4				2 - 1
	source	[ <u>1]</u> [	1 2	<b>  +</b> -'
4 5	source	<u>[1]</u>	1 2	

[1] Connected to flange.

# 3. Ordering information

#### Table 3. Ordering information

Type number	Package	Package		
	Name Description		Version	
BLP05H6700XR	HSOP4F	plastic, heatsink small outline package; 4 leads (flat)	SOT1138-2	
BLP05H6700XRG	HSOP4	plastic, heatsink small outline package; 4 leads	SOT1204-2	

## 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	135	V
V <sub>GS</sub>	gate-source voltage		-6	+11	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>case</sub>	case temperature		-	150	°C
Tj	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

# 5. Thermal characteristics

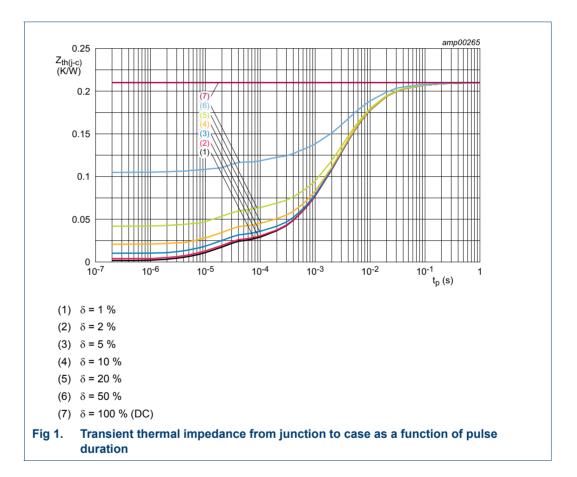
#### Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R <sub>th(j-case)</sub>	thermal resistance from junction to case	T <sub>j</sub> = 150 °C	<u>[1][2]</u>	0.21	K/W
Z <sub>th(j-case)</sub>	transient thermal impedance from junction to case	$T_j = 150 \ ^{\circ}C; t_p = 100 \ \mu s; \delta = 20 \ \%$	<u>[3]</u>	0.064	K/W

[1] T<sub>j</sub> is the junction temperature.

[2]  $R_{th(j-c)}$  is measured under RF conditions.

[3] see Figure 1.



## 6. Characteristics

#### Table 6. DC characteristics

 $T_i = 25 \,^{\circ}$ C per section; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	V <sub>GS</sub> = 0 V; I <sub>D</sub> = 2.75 mA	135	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 275 mA	1.33	1.9	2.33	V
V <sub>GSq</sub>	gate-source quiescent voltage	V <sub>DS</sub> = 50 V; I <sub>D</sub> = 50 mA	-	2.1	-	V
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V	-	-	1.4	μA
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 V;$ $V_{DS} = 10 V$	-	36	-	A
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V	-	-	140	nA
R <sub>DS(on)</sub>	drain-source on-state resistance	V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V; I <sub>D</sub> = 9.625 A	-	0.16	-	Ω

#### Table 7. AC characteristics

 $T_i = 25 \ ^{\circ}C$  per section; unless otherwise specified.

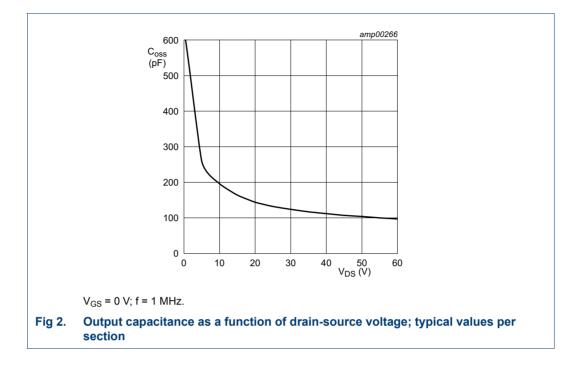
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
C <sub>rs</sub>	feedback capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V; f = 1 MHz	-	2.75	-	pF
C <sub>iss</sub>	input capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V; f = 1 MHz	-	297	-	pF
C <sub>oss</sub>	output capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V; f = 1 MHz	-	104	-	pF

#### Table 8. RF characteristics

Test signal: pulsed RF;  $t_p = 100 \ \mu s$ ;  $\delta = 20 \ \%$ ;  $f = 108 \ MHz$ ; RF performance at  $V_{DS} = 50$ ;  $I_{Dq} = 100 \ mA$ ;  $T_{case} = 25 \ \%$ ; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G <sub>p</sub>	power gain	P <sub>L</sub> = 700 W	25	26	-	dB
RL <sub>in</sub>	input return loss	P <sub>L</sub> = 700 W	-	–13	-	dB
η <sub>D</sub>	drain efficiency	P <sub>L</sub> = 700 W	72	75	-	%

**Power LDMOS transistor** 

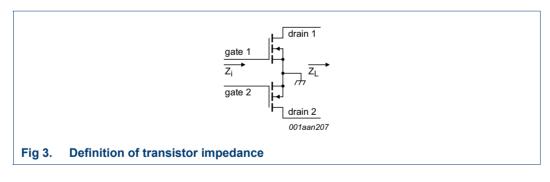


# 7. Test information

#### 7.1 Ruggedness in class-AB operation

The BLP05H6700XR and the BLP05H6700XRG are capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions:  $V_{DS} = 50 \text{ V}$ ;  $I_{Dq} = 100 \text{ mA}$ ;  $P_L = 700 \text{ W}$  pulsed; f = 108 MHz.

### 7.2 Impedance information



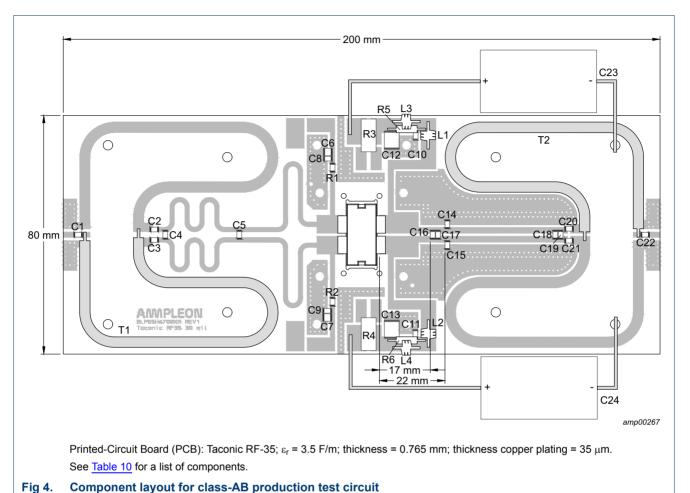
#### Table 9. Typical push-pull impedance

Simulated  $Z_i$  and  $Z_L$  device impedance; impedance info at  $V_{DS}$  = 50 V and  $P_L$  = 700 W.

f	Zi	ZL
(MHz)	(Ω)	(Ω)
108	5.9 – j19.1	5.5 + j1.1

# BLP05H6700XR; BLP05H6700XRG

**Power LDMOS transistor** 



### 7.3 Test circuit

# Table 10.List of componentsFor test circuit see Figure 4.

Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	510 pF [1]	ATC 100B
C2, C3	multilayer ceramic chip capacitor	62 pF [1]	ATC 100B
C4	multilayer ceramic chip capacitor	20 pF [1]	ATC 100B
C5	multilayer ceramic chip capacitor	160 pF [1]	ATC 100B
C6, C7	multilayer ceramic chip capacitor	4.7 μF, 100 V	
C8, C9	multilayer ceramic chip capacitor	820 pF [1]	ATC 100B
C10, C11	multilayer ceramic chip capacitor	820pF [1]	ATC 100B
C12, C13	multilayer ceramic chip capacitor	4.7 μF, 100 V	
C14, C15	multilayer ceramic chip capacitor	91 pF [1]	ATC 100B
C16	multilayer ceramic chip capacitor	36 pF [1]	ATC 100B
C17	multilayer ceramic chip capacitor	22 pF [1]	ATC 100B
C18, C19	multilayer ceramic chip capacitor	47 pF [1]	ATC 100B
C20, C21	multilayer ceramic chip capacitor	120 pF [1]	ATC 100B

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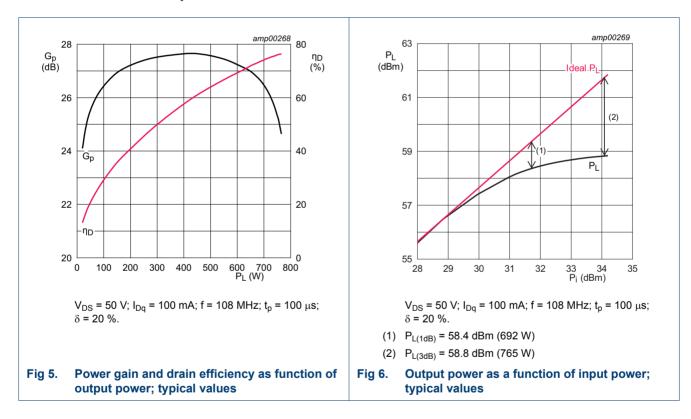
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**Power LDMOS transistor** 

Component	Description	Value	Remarks
C22	multilayer ceramic chip capacitor	220 pF [1]	ATC 100B
C23, C24	electrolytic capacitor	2200 μF, 64 V	
L1, L2	air inductor	10 turns, d = 2 mm	0.5 mm copper wire
L3, L4	air inductor	6 turns, d = 2 mm	0.5 mm copper wire
R1, R2	resistor	4.7 kΩ	SMD 1206
R3, R4	shunt resistor	0.01 Ω	FC4L110R010FER
R5, R6	metal film resistor	10 Ω, 0.6 W	
T1, T2	semi rigid coax	50 Ω, 160 mm	EZ 86-TP/M17

# Table 10. List of components ...continued For test circuit see Figure 4.

[1] American Technical Ceramics type 100B or capacitor of same quality.

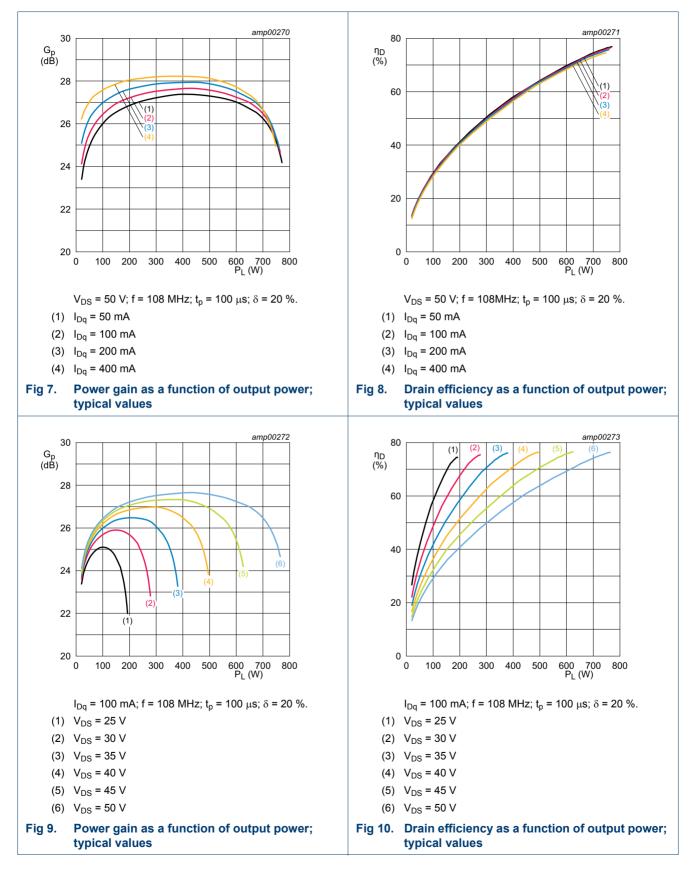


#### 7.4 Graphical data

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**Power LDMOS transistor** 



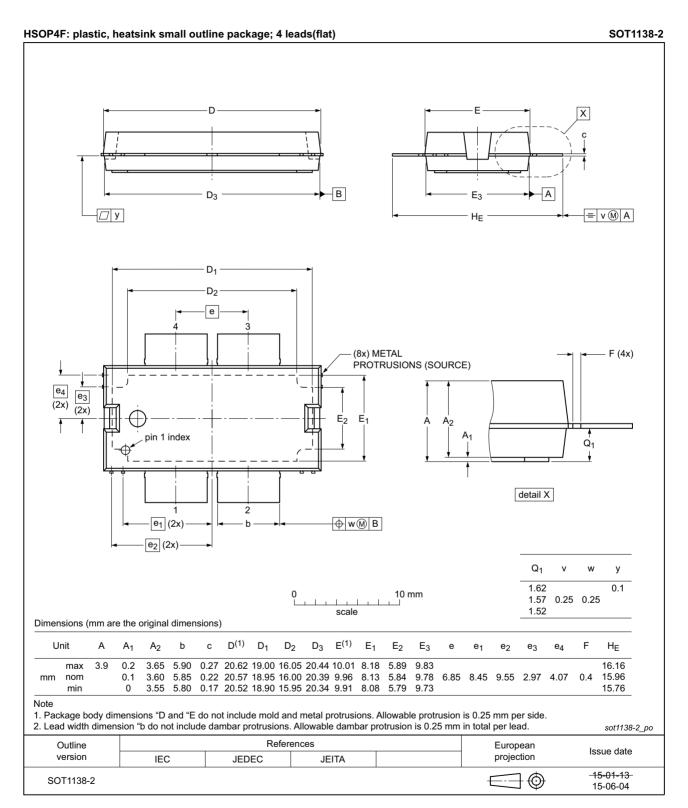
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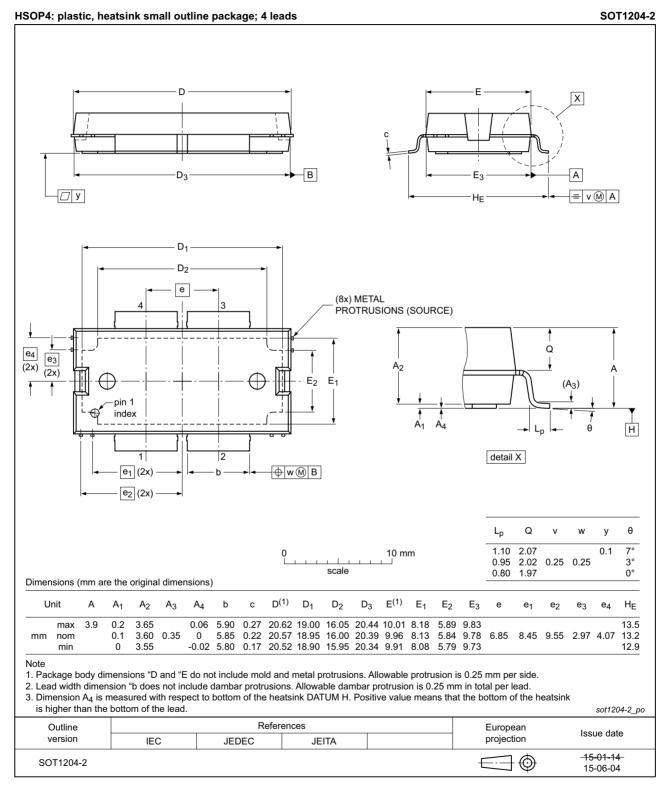
## 8. Package outline



#### Fig 11. Package outline SOT1138-2 (HSOP4F)

# BLP05H6700XR; BLP05H6700XRG

**Power LDMOS transistor** 



#### Fig 12. Package outline SOT1204-2 (HSOP4)

# 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### Table 11.ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard	JS-002 C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-	-001 2 🛛

 CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V, but fails after exposure to an ESD pulse of 750 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

## **10. Abbreviations**

Table 12. Abbreviations				
Acronym	Description			
ESD	ElectroStatic Discharge			
HF	High Frequency			
LDMOS	Laterally Diffused Metal-Oxide Semiconductor			
MTF	Median Time to Failure			
SMD	Surface Mounted Device			
VSWR	Voltage Standing-Wave Ratio			

## 11. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLP05H6700XR_H6700XRG v.1	20170217	Product data sheet	-	-

# 12. Legal information

#### 12.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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